

# 1N5817, 1N5818, 1N5819

### Low drop power Schottky rectifier

### **Features**

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low forward voltage drop
- Avalanche capability specified

### **Description**

Axial Power Schottky rectifier suited for Switch Mode Power Supplies and high frequency DC to DC converters. Packaged in DO-41 these devices are intended for use in low voltage, high frequency inverters, free wheeling, polarity protection and small battery chargers.

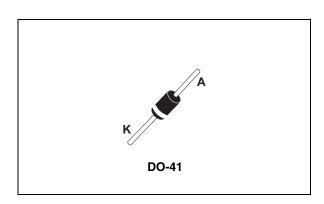


Table 1. Device summary

Symbol	Value	Unit
I <sub>F(AV)</sub>	1	Α
$V_{RRM}$	40	V
Tj	150	°C
V <sub>F</sub> (max)	0.45	V

#### **Characteristics** 1

Table 2. **Absolute ratings (limiting values)** 

Cymbol	Parameter -		Value			Unit
Symbol			1N5817	1N5818	1N5819	Offic
V <sub>RRM</sub>	Repetitive peak reverse voltage		20	30	40	V
I <sub>F(RMS)</sub>	Forward rms current		10			Α
I <sub>F(AV)</sub>	Average forward current $T_L = 125  ^{\circ}\text{C},  \delta = 0.5$		1			Α
I <sub>FSM</sub>			25			Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 1 \mu s, T_j = 25 ^{\circ}C$		1200	1200	900	W
T <sub>stg</sub>	Storage temperature range		-65 to + 150			°C
Tj	Maximum operating junction temperature <sup>(1)</sup>		150		°C	
dV/dt	Critical rate of rise of reverse voltage		10000			V/µs

 $<sup>\</sup>frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink.

Table 3. Thermal resistances

Symbol	Paramete	Value	Unit	
R <sub>th (j-a)</sub>	Junction to ambient	Lead length = 10 mm	100	°C/W
R <sub>th (j-l)</sub>	Junction to lead	Lead length = 10 mm	45	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		1N5817	1N5818	1N5819	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage	T <sub>j</sub> = 25 °C	V -V	0.5	0.5	0.5	mA
'R ` current	T <sub>j</sub> = 100 °C	$V_R = V_{RRM}$	10	10	10	mA	
V <sub>E</sub> (1)	V (1) Forward voltage drap	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 1 A	0.45	0.50	0.55	V
V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	$I_F = 3 A$	0.75	0.80	0.85	V	

<sup>1.</sup> Pulse test :  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

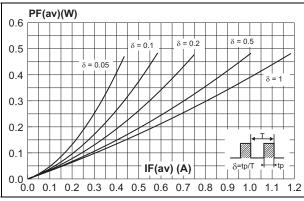
To evaluate the conduction losses use the following equations : P = 0.3 x  $I_{F(AV)}$  + 0.090  $I_{F^2(RMS)}$  for 1N5817 / 1N5818 P = 0.3 x  $I_{F(AV)}$  + 0.150  $I_{F^2(RMS)}$  for 1N5819

$$P = 0.3 \times I_{F(AV)} + 0.150 I_{F}^{2}_{(RMS)}$$
 for 1N5819

Doc ID 6262 Rev 5

Figure 1. Average forward power dissipation Figure 2. versus average forward current (1N5817/1N5818)

gure 2. Average forward power dissipation versus average forward current (1N5819)



PF(av)(W)

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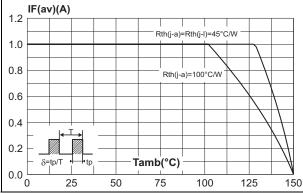
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Figure 3. Average forward current versus ambient temperature  $(\delta = 0.5)$  (1N5817/1N5818)

Figure 4. Average forward current versus ambient temperature  $(\delta = 0.5)$  (1N5819)



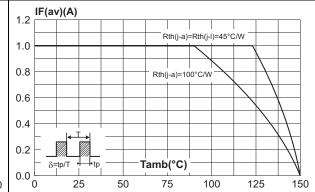


Figure 5. Normalized avalanche power derating versus pulse duration

Figure 6. Normalized avalanche power derating versus junction temperature

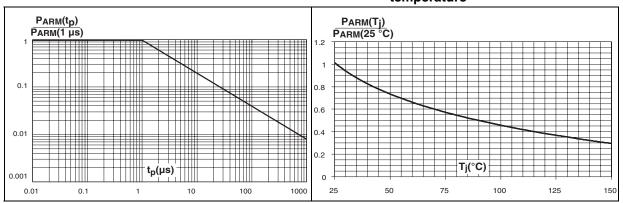
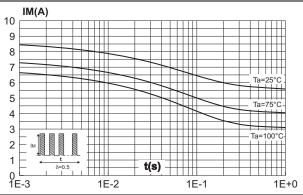


Figure 7. Non repetitive surge peak forward current versus overload duration (maximum values) (1N5817/1N5818)

Figure 8. Non repetitive surge peak forward current versus overload duration (maximum values) (1N5819)



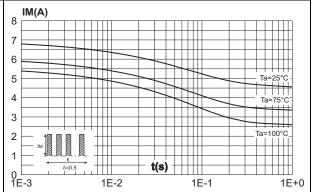
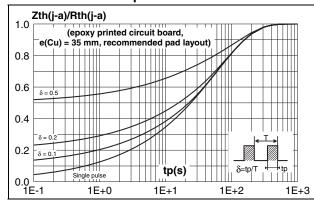


Figure 9. Relative variation of thermal impedance junction to ambient versus pulse duration

Figure 10. Junction capacitance versus reverse voltage applied (typical values)



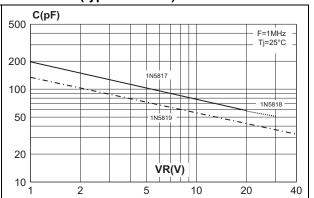
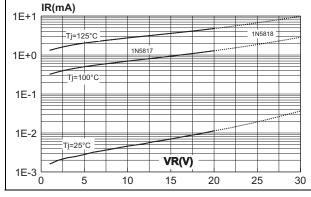
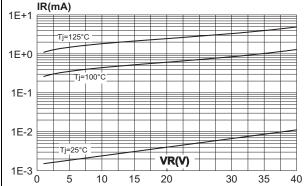


Figure 11. Reverse leakage current versus reverse voltage applied (typical values) (1N5817/1N5818)

Figure 12. Reverse leakage current versus reverse voltage applied (typical values) (1N5819)





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4/7

Figure 13. Forward voltage drop versus forward current (typical values) (1N5817/1N5818)

Figure 14. Forward voltage drop versus forward current (typical values) (1N5819)

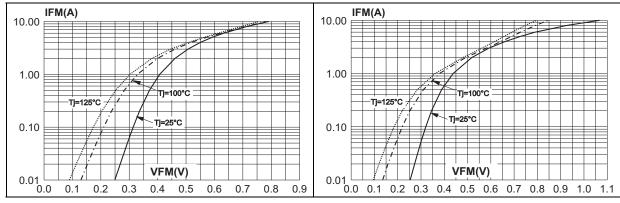
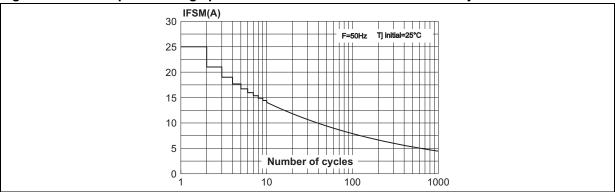


Figure 15. Non repetitive surge peak forward current versus number of cycles

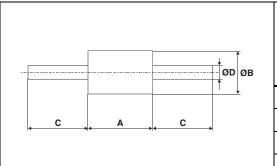


### 2 Package Information

- Epoxy meets UL94, V0
- Band indicates cathode

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Table 5. DO-41 (Plastic) dimensions



	Dimensions					
Ref.	Millimeters Min. Max.		Inc	hes		
			Min.	Max.		
Α	4.07	5.20	0.160	0.205		
В	2.04	2.71	0.080	0.107		
С	25.4		1			
D	0.71	0.86	0.028	0.034		

### 3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
1N581x	Part number cathode ring	DO-41	0.34 g	2000	Ammopack
1N581xRL	Part number cathode ring	DO-41	0.34 g	5000	Tape and reel

## 4 Revision history

Table 7. Document revision history

Date	Revision	Changes	
Jul-2003	4A	Last update.	
04-Jul-2011	5	Updated Table 5.: DO-41 (Plastic) dimensions.	

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Doc ID 6262 Rev 5 7/7